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SEMICONDUCTOR DEVICE

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[There are no amendments to this patent.]

Claim-

A type of semiconductor device characterized by the following constitution:

in the semiconductor device, lower and upper semiconductor elements (9) and (12), respectively, overlap and are carried in same package (7), and at the same time, said package (7) is sealed by cap (15); in this semiconductor device,

said cap (15) is fixed on the upper portion of said upper semiconductor element (12), and at the same time, step portion (15a) is formed on said cap (15).

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